EVERLIGHT

DATASHEET

SMD • B 19-213-S3SC-B0S1T1B0E-3T-AM



Features

- RoHS compliant
- •Chip LED package.
- •Colorless clear resin.
- •Wide viewing angle 120°
- •Brightness:180 to 355 mcd at 20mA.
- •Qualification according to AEC-Q101.
- •Precondition: Bases on JEDEC J-STD 020 Level 3.
- •Automotive reflow profile (IR reflow or wave soldering)
- •Compliance with EU REACH
- •Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Applications

- •Automotive backlighting or indicator: Dashboard, switch, audio and video equipments...etc.
- •Backlight: LCD, switches, symbol, mobile phone and illuminated advertising.
- •Display for indoor and outdoor application.
- ·ldeal for coupling into light guides.
- •Substitution of traditional light.
- •Optical indicator.
- General applications.

Device Selection Guide

Chip Materials	Emitted Color	Resin Color	
AlGaInP	Reddish Orange	Water Clear	

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V _R	12	V	
Forward Current	I _F	50	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA	
Power Dissipation	Pd	120	mW	
Junction Temperature	Тj	125	°C	
Operating Temperature	T _{opr}	-40 ~ +100	°C	
Storage Temperature	Tstg	-40 ~ +110	°C	
Thermal Resistance	Rth _{J-A}	800	K/W	
	Rth _{J-S}	450	K/W	
ESD	ESD _{HBM}	2000	V	
(Classification acc. AEC Q101)	ESD _{MM}	200	V	
Soldering Temperature	T _{sol}		Reflow Soldering : 260 $^{\circ}$ C for 30 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	180		355	mcd	
Viewing Angle	20 _{1/2}		120		deg	
Peak Wavelength	λр		621		nm	I₌=20mA
Dominant Wavelength	λd	613.5		621.5	nm	— I _F -2011A
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	V _F	1.75		2.35	V	
Reverse Current	I _R			10	μA	V _R =12V
Temperature coefficient of λp	$TC_{\lambda p}$		0.13		nm/K	
Temperature coefficient of λd	$TC_{\lambda d}$		0.08		nm/K	I _F =20mA
Temperature coefficient of V_F	TCv		-4.3		mV/K	

Note:

1. Tolerance of Luminous Intensity: ±11%

2. Tolerance of Dominant Wavelength: ±1nm

3. Tolerance of Forward Voltage: ±0.1V



Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
S1	180	224		
S2	224	280	mcd	I _F =20mA
T1	280	355		-

Note:

Tolerance of Luminous Intensity: ±11%

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
E3	613.5	617.5		L 00.55 A
E4	617.5	621.5	nm	I _F =20mA

Note:

Tolerance of Dominant Wavelength: ±1nm



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Typical Electro-Optical Characteristics Curves



Typical Curve of Spectral Distribution

Note: V(λ)=Standard eye response curve; I_F =20mA

Diagram Characteristics of Radiation













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Package Dimension



Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

Moisture Resistant Packing Materials

Label Explanation

Reel Dimensions



Label Explanation

- CPN: Customer's Product Number
- P/N: Product Number
- **QTY:** Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

2.0±0.5 Label₂ ø60.0 🏰 Ø180±2.0 ø13.0±0.2 90:33 -11.4±1.0

Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Carrier Tape Dimensions: Loaded Quantity 3000 pcs Per Reel



Q

Label

Desiccant

Aluminum moisture-proof bag

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Label

Precautions for Use

1. Soldering Condition (Reference: IPC/JEDEC J-STD-020D) a. IR reflow



(B) Recommend soldering pad

Recommend Sodering Pod





Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

2. Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.

- 3. Storage
 - 3.1 Moisture proof bag should only be opened immediately prior to usage.
 - 3.2 Environment should be less than 30 $^\circ$ C and 60% RH when moisture proof bag is opened.
 - 3.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.
 - 3.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg +/-5deg for 24 hours.
- 4. Iron Soldering

Hand soldering is not recommended for regular production. These guidelines are for rework only. Soldering iron tip should contact each terminal no more than 3 sec at 350° C, using soldering iron with nominal power

less than 25W. Allow min. 2 sec. between soldering intervals.

5. Usage

Do not exceed the values given in this specification.

Application Restrictions

1. High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

Revision History:

Rev.	Modified date	File modified contents
1	2012/4/8	New Spec
2	2014/9/9	Release